



THE INSTITUTION OF ENGINEERS, MALAYSIA

Bangunan Ingenieur, Lots 60 & 62, Jalan 52/4, P.O. Box 223, Jalan Sultan, 46720 Petaling Jaya
Tel: 03-7968 4001/4002 Fax: 03-7957 7678 E-mail: sec@iem.org.my
Homepage: <http://www.iem.org.my>

PROFESSIONAL INTERVIEW WORKSHOP

(Organised by Professional Interview Board, IEM)

BEM Approved
PDP Hours: 3
IEM11 /HQ/PDP/005/W

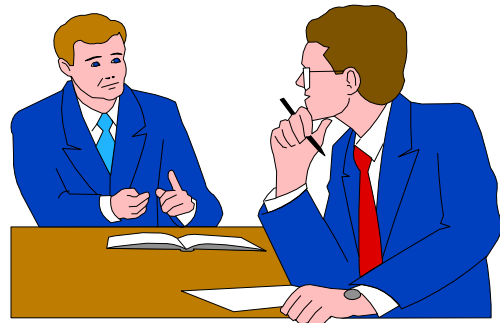
Date : 22 October 2011 (Saturday)
Time : 9.30 am to 12.00 noon (Refreshment will be served at 9.00 am)
Venue : Tan Sri Prof. Chin Fung Kee Auditorium, 3rd Floor, Wisma IEM, Petaling Jaya
Speakers : Ir. Ishak bin Abdul Rahman (Civil)
Ir. Mohd Aman bin Haji Idris (Electrical / Electronic)
Ir. Gopal Narian Kutty (Mechanical)
Ir. Juares Rizal bin Abdul Hamid (Chemical / Others)

Registration fee

Members	RM 10.00
Non Members	RM 50.00

The workshop will cover the following:

- Purpose of Professional Interview
- Guidelines for Professional Interview
- Presentation at the Interview
 - Submission of Reports
 - Oral Interview
 - Essay writing
- Code of Ethics



The workshop is to serve as a clarification session for “would-be” Corporate Members. All graduate members with more than 3 years experience are encouraged to attend the workshop and to apply for the Professional Interview thereafter. Members who are interested to participate are requested to return the reply slip to the IEM Secretariat by **12 October 2011** together with the commitment fee payable to *The Institution of Engineers, Malaysia*. Please note that the **commitment fee must be settled prior to the workshop.**

Ir. Hoo Choon Sean
Chairman
Professional Interview Board

Reply Slip (Fax to: 03- 7957 7678)

Chairman
Professional Interview Sub Committee
The Institution of Engineers, Malaysia

PROFESSIONAL INTERVIEW WORKSHOP

I wish to participate in the Professional Interview workshop on **22 October 2011 (Saturday)**. I enclose herewith a cheque No./Cash..... for the amount of..... as my commitment fee for the workshop.

Name of Member: M'ship No:

Address: Grade:

..... Email:

..... Tel (H/P):

Company's Name: I/C No. of Participant:

.....
Signature

.....
Date

(Photostat copies are acceptable)